

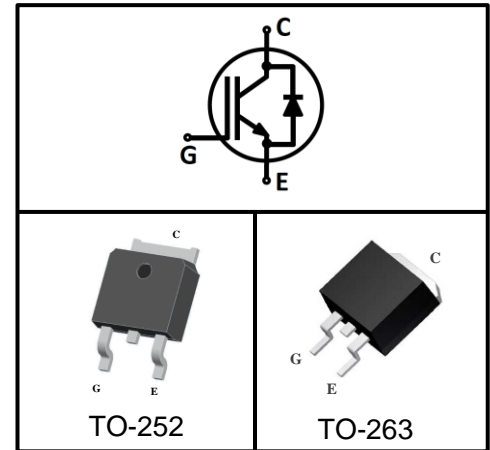
Features

- Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Low V_{CEsat} , fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

Type	Marking	Package Code
MPBD6N65ESF	MP6N65ESF	TO-252
MPBC6N65ESF	MP6N65ESF	TO-263

Applications

- Motor Drives
- Fan, Pumps, Vacuum Cleaner



Maximum Rated Values ¹

Parameter	Symbol	Value		Unit
		TO-252	TO-263	
Collector-emitter voltage	V_{CE}	650		V
DC collector current ²	I_C	10		A
$T_C=25^\circ\text{C}$		6		
$T_C=100^\circ\text{C}$		18		
Pulsed collector current ³	I_{Cpuls}	18		
Diode forward current ²	I_F	10		
$T_C=25^\circ\text{C}$		6		
$T_C=100^\circ\text{C}$		18		
Diode pulsed current ³	I_{Fpuls}	18		
Short circuit withstanding time $V_{GE} = 15\text{V}, V_{CC} \leq 400\text{V}, T_J \leq 150^\circ\text{C}$	t_{SC}	5		us
Gate-emitter voltage	V_{GE}	± 20		V
Transient Gate-emitter voltage ($t_p \leq 10\mu\text{s}$)		± 30		
Power dissipation	P_{tot}	100		W
$T_C=25^\circ\text{C}$		50		
$T_C=100^\circ\text{C}$				
Operating junction temperature	T_j	-55~175		°C
Storage temperature	T_{stg}	-55~150		

1:Reference standard: JESD-022 2: limited by T_{jmax} 3: T_p limited by T_{jmax} ;



Thermal Characteristics

Parameter	Symbol	TO-252	TO-263	Unit
IGBT thermal resistance, junction-case	R_{thJC}	1.5	1.5	K/W
Diode thermal resistance, junction-case	R_{thJCD}	2.1	2.6	
Thermal Resistance, junction-ambient	R_{thJA}	72	51	

Electrical Characteristics (at $T_j=25^\circ\text{C}$, unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=0.25mA$	650	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=6A, T_j=25^\circ\text{C}$	-	1.40	1.80	
		$T_j=125^\circ\text{C}$	-	1.46	-	
		$T_j=150^\circ\text{C}$	-	1.49	-	
Diode forward voltage	V_F	$V_{GE}=0V, I_F=6A, T_j=25^\circ\text{C}$	-	1.70	2.10	
		$T_j=125^\circ\text{C}$	-	1.60	-	
		$T_j=150^\circ\text{C}$	-	1.55	-	
G-E threshold voltage	$V_{GE(th)}$	$I_C=150\mu A, V_{CE}=V_{GE}$	4.7	5.7	6.7	
C-E leakage current	I_{CES}	$V_{CE}=650V, V_{GE}=0V, T_j=25^\circ\text{C}$	-	-	0.01	
		$T_j=150^\circ\text{C}$	-	-	1.0	
G-E leakage current	I_{GES}	$V_{CE}=0V, V_{GE}=20V$	-	-	250	nA
Transconductance	g_{FS}	$V_{CE}=20V, I_C=6A$	-	2	-	S

Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input capacitance	C_{iss}	$V_{CE}=25V, V_{GE}=0V, f=1MHz$	-	575	-	pF
Output capacitance	C_{oss}		-	33	-	
Reverse transfer capacitance	C_{rss}		-	5	-	
Gate charge	Q_G	$V_{CC}=300V, I_C=6A, V_{GE}=15V$	-	25	-	nC



IGBT Switching Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit	
Turn-on delay time	$t_{d(on)}$	$T_j=25^{\circ}\text{C}$, $V_{CC}=400\text{V}$, $I_C=6\text{A}$, $V_{GE}=0/15\text{V}$, $R_G=10\Omega$, Inductive load	-	60	-	ns	
Rise time	t_r		-	36	-		
Turn-off delay time	$t_{d(off)}$		-	87	-		
Fall time	t_f		-	102	-		
Turn-on energy	E_{on}		$T_j=150^{\circ}\text{C}$, $V_{CC}=400\text{V}$, $I_C=6\text{A}$, $V_{GE}=0/15\text{V}$, $R_G=10\Omega$, Inductive load	-	0.129	-	mJ
Turn-off energy	E_{off}			-	0.129	-	
Total switching energy	E_{ts}			-	0.258	-	
Turn-on delay time	$t_{d(on)}$	-		54	-		
Rise time	t_r	-	27.6	-	ns		
Turn-off delay time	$t_{d(off)}$	-	129	-			
Fall time	t_f	-	140	-			
Turn-on energy	E_{on}	$T_j=150^{\circ}\text{C}$, $V_{CC}=400\text{V}$, $I_C=6\text{A}$, $V_{GE}=0/15\text{V}$, $R_G=10\Omega$, Inductive load	-	0.173	-	mJ	
Turn-off energy	E_{off}		-	0.183	-		
Total switching energy	E_{ts}		-	0.356	-		

Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode reverse recovery time	t_{rr}	$T_j=25^{\circ}\text{C}$, $V_R=400\text{V}$, $I_F=6\text{A}$, $di_F/dt=200\text{A}/\mu\text{s}$	-	79	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.178	-	μC
Diode peak reverse recovery current	I_{rrm}		-	3.5	-	A
Diode reverse recovery time	t_{rr}	$T_j=150^{\circ}\text{C}$, $V_R=400\text{V}$, $I_F=6\text{A}$, $di_F/dt=200\text{A}/\mu\text{s}$	-	151	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.475	-	μC
Diode peak reverse recovery current	I_{rrm}		-	6.4	-	A

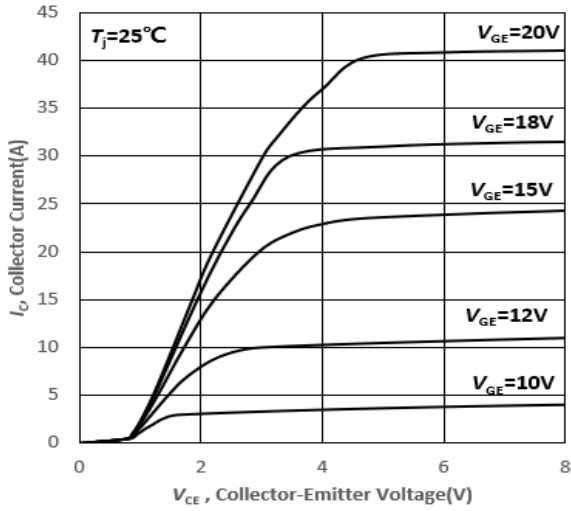


Figure 1. Typical output characteristic ($T_j = 25^\circ\text{C}$)

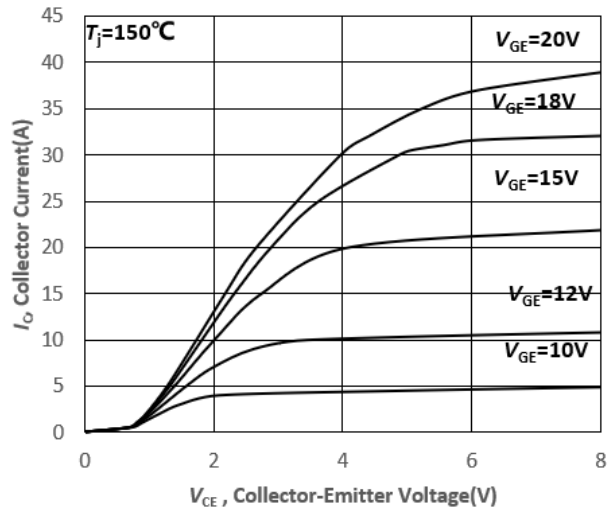


Figure 2. Typical output characteristic ($T_j = 150^\circ\text{C}$)

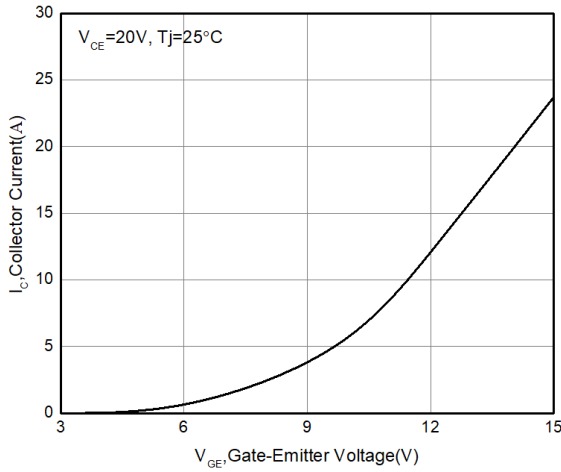


Figure 3. Typical transfer characteristic ($T_j = 25^\circ\text{C}$)

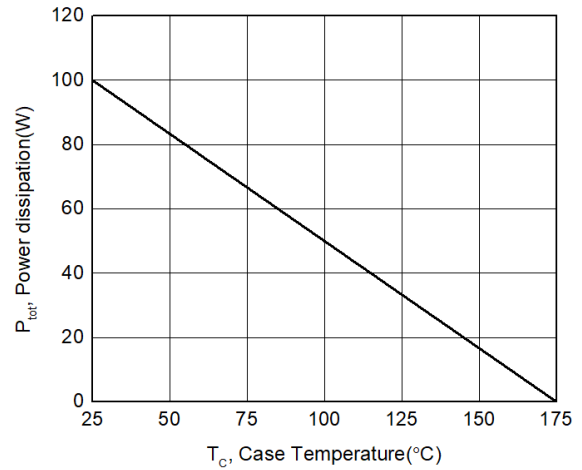


Figure 4. Power dissipation as a function of case temperature ($T_j \leq 175^\circ\text{C}$)

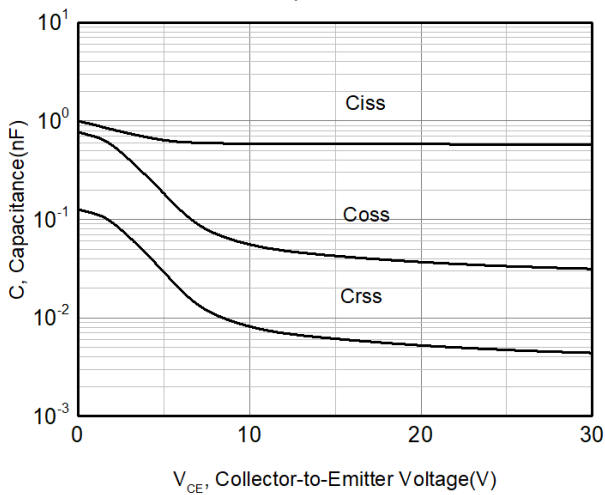


Figure 5. Capacitance characteristic ($V_{GE} = 0\text{V}$, $f = 1\text{MHz}$)

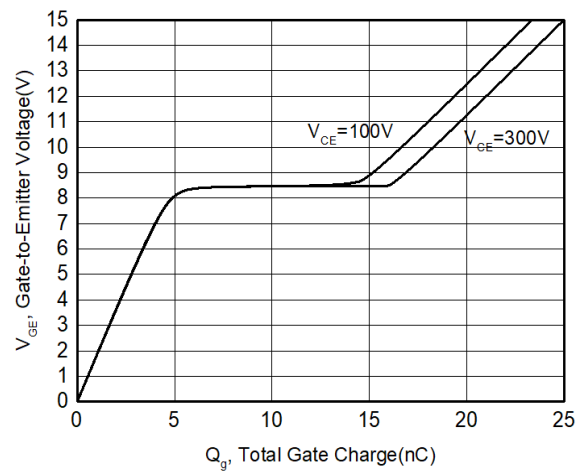


Figure 6. Typical gate charge ($I_C = 6\text{A}$)

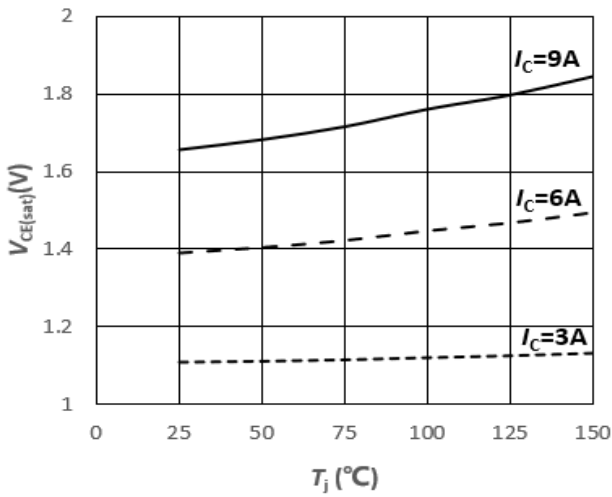


Figure 7. V_{CESAT} as a function of junction temperature ($V_{GE}=15V$)

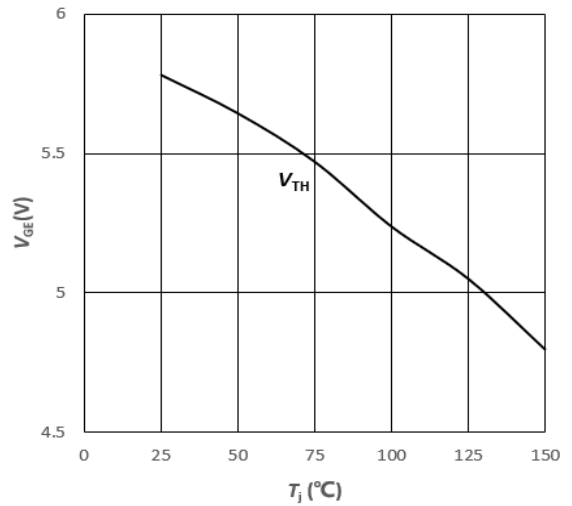


Figure 8. V_{TH} as a function of junction temperature ($I_{CE}=250\mu A$)

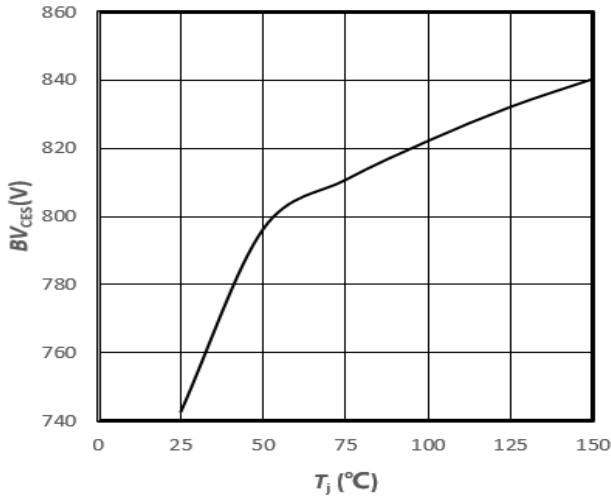


Figure 9. BV as a function of junction temperature ($I_{CE}=250\mu A$)

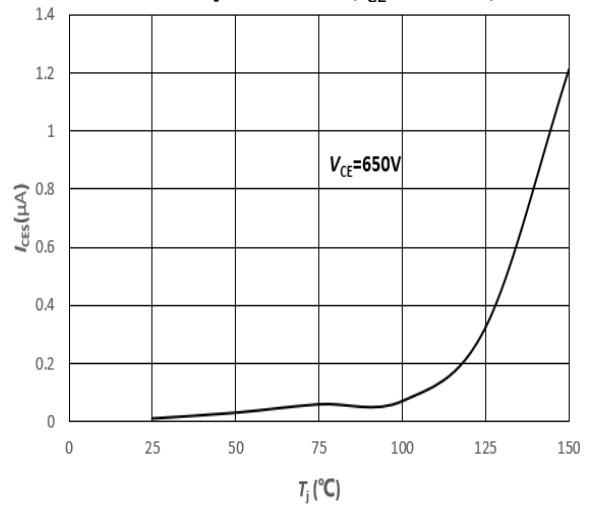


Figure 10. I_{CES} leakage current as a function of junction temperature

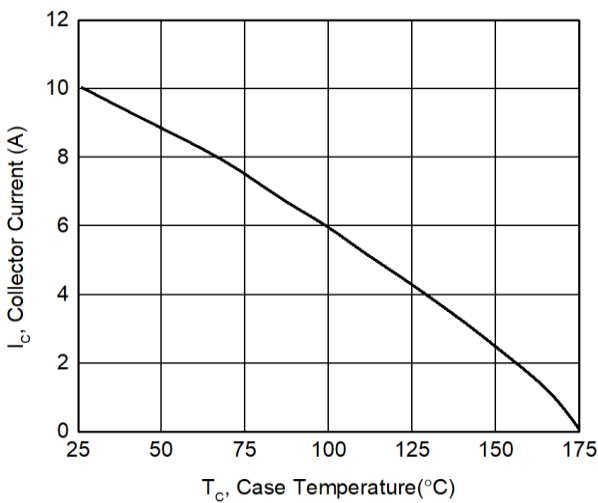


Figure 11. Collector current as a function of case temperature ($V_{GE} \geq 15V$, $T_j \leq 150^\circ C$)

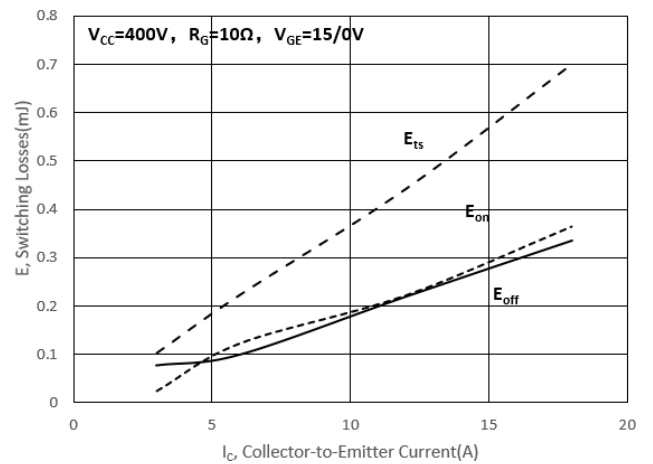


Figure 12. E_{on} , E_{off} as a function of I_C ($T_j=25^\circ C$)

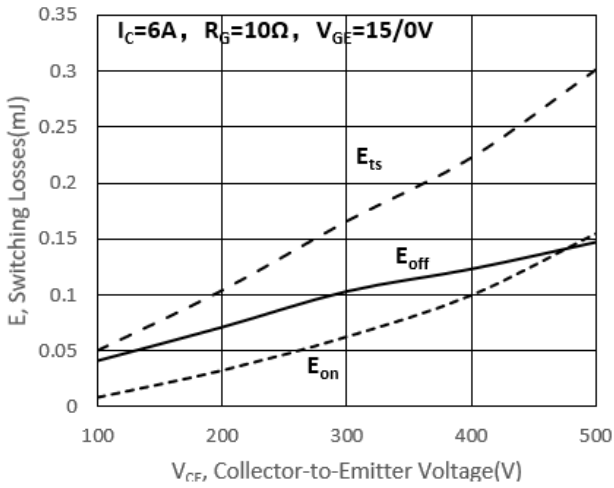


Figure 13. E_{on} , E_{off} as a function of V_{CE} ($T_j=25^\circ\text{C}$)

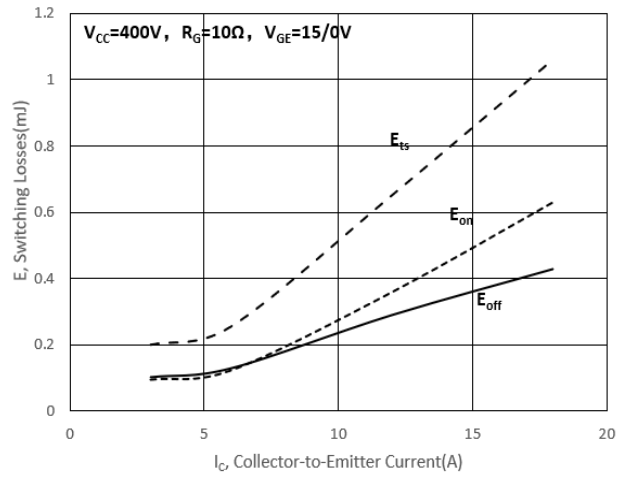


Figure 14. E_{on} , E_{off} as a function of I_C ($T_j=150^\circ\text{C}$)

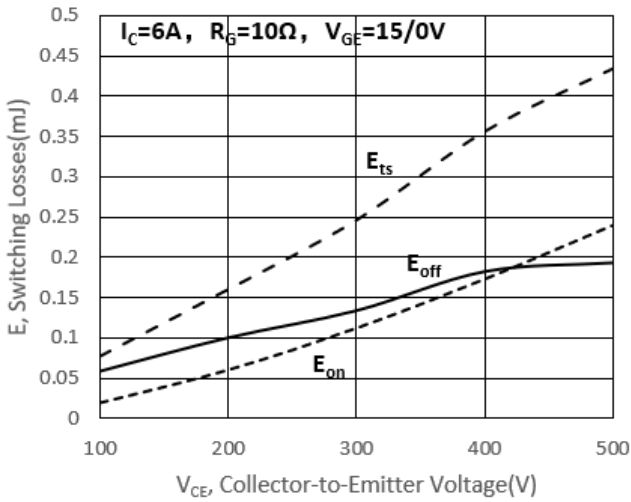


Figure 15. E_{on} , E_{off} as a function of V_{CE} ($T_j=150^\circ\text{C}$)

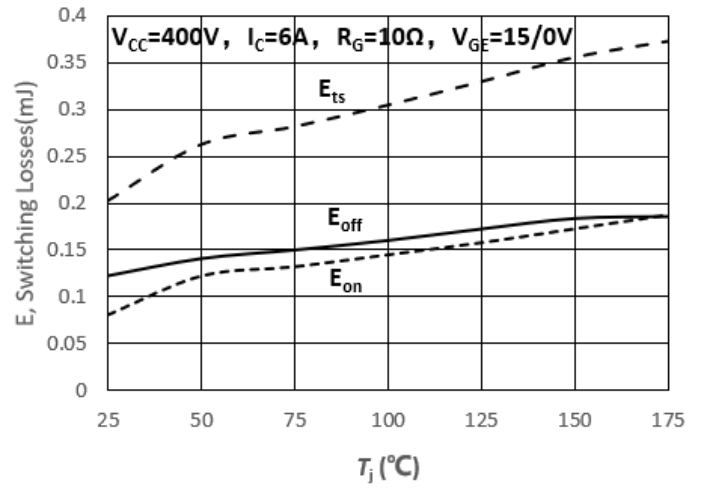
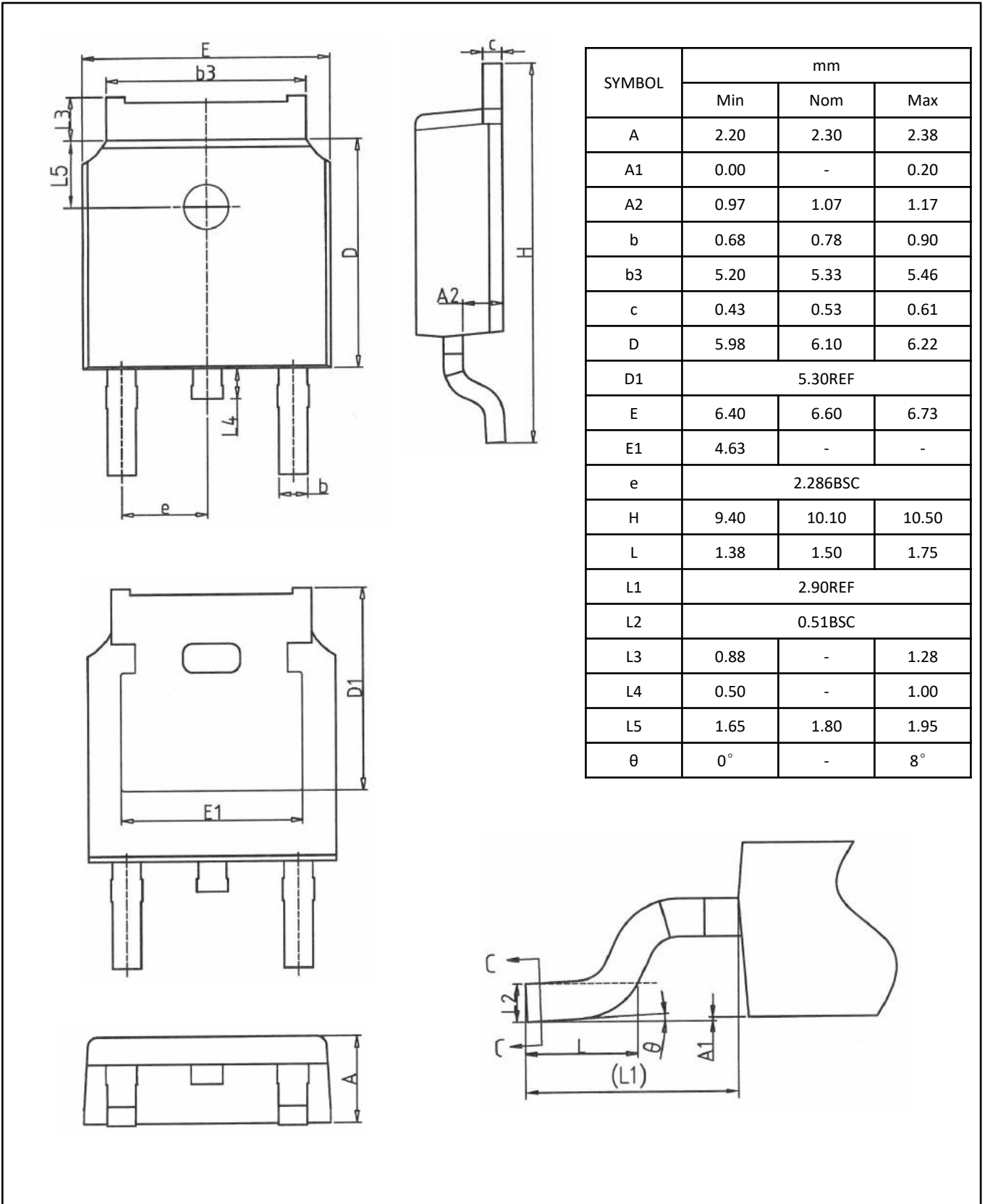
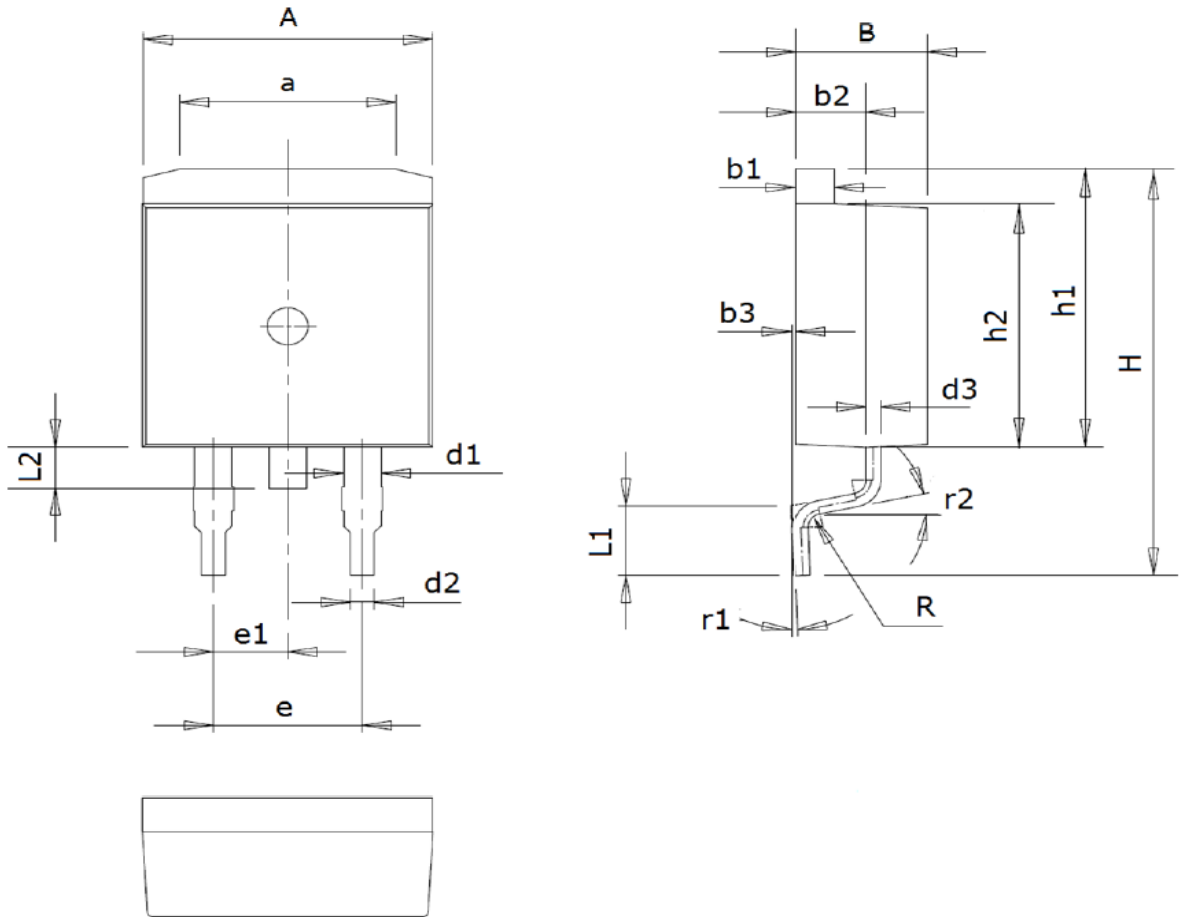


Figure 16. E_{on} , E_{off} as a function of junction temperature

TO-252



TO-263



Symbol	Dimensions (mm)	Symbol	Dimensions (mm)	Symbol	Dimensions (mm)
A	9.86~10.26	d2	0.7~0.96	L1	2.0~2.6
a	7.0~7.8	d3	0.3~0.53	L2	1.3~1.8
B	4.37~4.77	e	5.08	R	0.5
b1	1.22~1.42	e1	2.54	r1	0-9°
b2	2.2~2.6	H	14.7~15.5	r2	12°
b3	0~0.25	h1	10.3~10.7		
d1	1.17~1.47	h2	9.1~9.4		



Revision: 2022-11, Rev. 1.0

Revision	Date	Subjects (major changes since last revision)
1.0	2022-11	Initial version
1.1	2023-01	Add the graphs



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